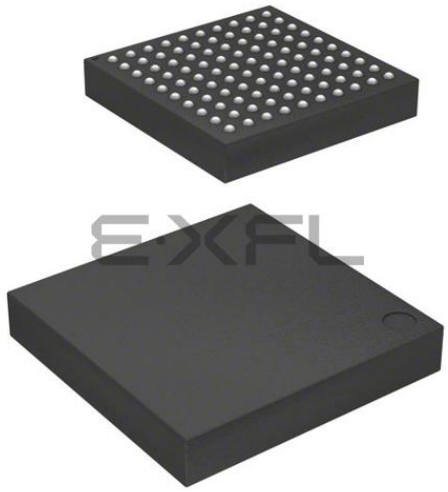
Renesas Electronics America Inc - R5F565N7BDLJ#20 Datasheet



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Applications of "Embedded - Microcontrollers"

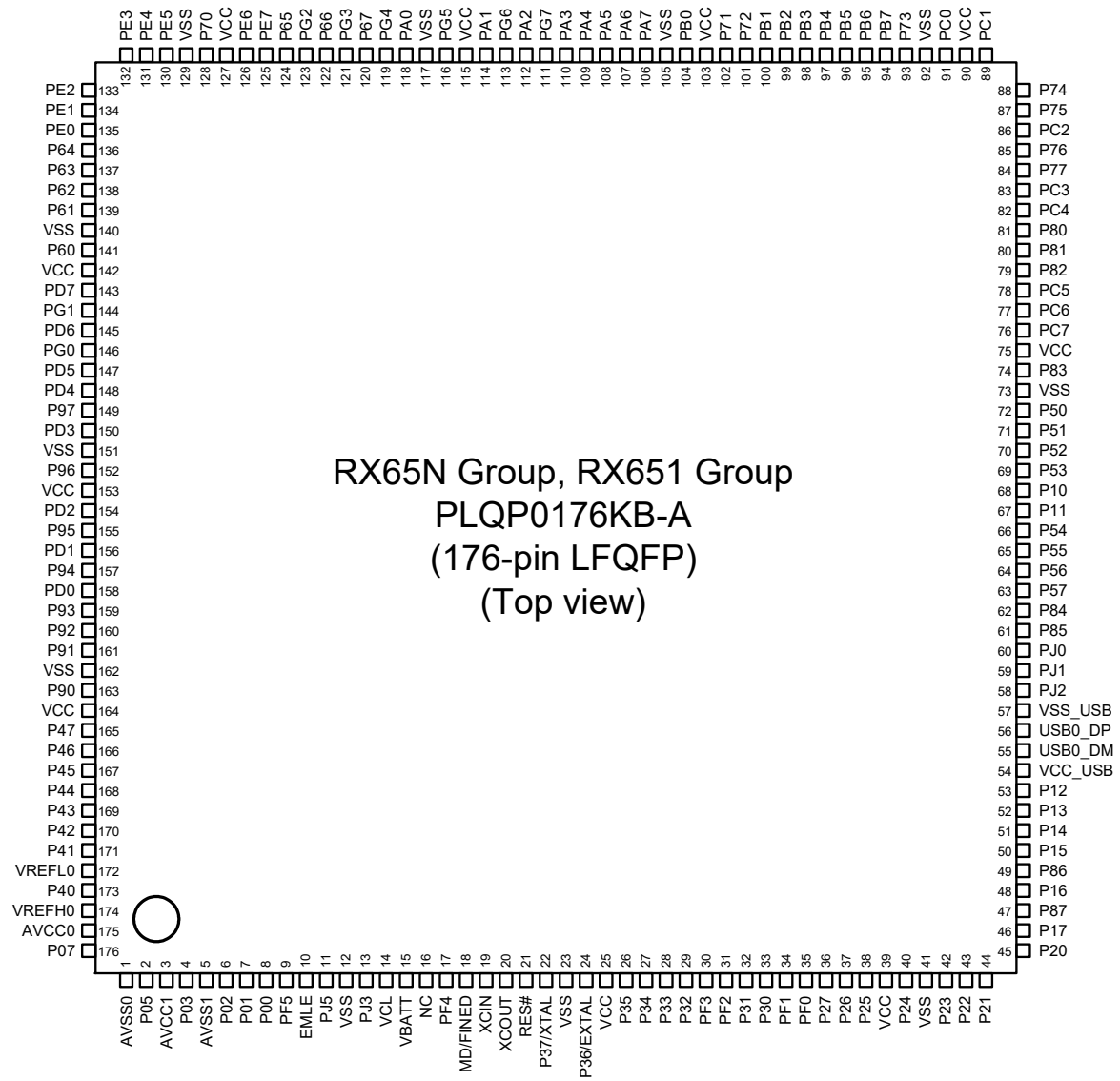
Details	
Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	120MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, LINbus, MMC/SD, QSPI, SCI, SPI, UART/USART, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	78
Program Memory Size	768KB (768K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 22x12b; D/A 1x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFLGA
Supplier Device Package	100-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f565n7bdlj-20

Table 1.1 Outline of Specifications (4/9)

Classification	Module/Function	Description
Event link controller (ELC)		• Event signals such as interrupt request signals can be interlinked with the operation of functions such as timer counting, eliminating the need for intervention by the CPU to control the functions. • 83 internal event signals can be freely combined for interlinked operation with connected functions. • Event signals from peripheral modules can be used to change the states of output pins (of ports B and E). • Changes in the states of pins (of ports B and E) being used as inputs can be interlinked with the operation of peripheral modules.
Timers	16-bit timer pulse unit (TPUa)	• (16 bits × 6 channels) × 1 unit • Maximum of 16 pulse-input/output possible • Select from among seven or eight counter-input clock signals for each channel • Input capture/output compare function • Output of PWM waveforms in up to 15 phases in PWM mode • Support for buffered operation, phase-counting mode (two phase encoder input) and cascade-connected operation (32 bits × 2 channels) depending on the channel. • PPG output trigger can be generated • Capable of generating conversion start triggers for the A/D converters • Digital filtering of signals from the input capture pins • Event linking by the ELC
	Multifunction timer pulse unit (MTU3a)	• 9 channels (16 bits × 8 channels, 32 bits × 1 channel) • Maximum of 28 pulse-input/output and 3 pulse-input possible • Select from among 14 counter-input clock signals for each channel (PCLKA/1, PCLKA/2, PCLKA/4, PCLKA/8, PCLKA/16, PCLK/A32, PCLKA/64, PCLKA/256, PCLKA/1024, MTCLKA, MTCLKB, MTCLKC, MTCLKD, MTIOC1A) 14 of the signals are available for channel 0, 11 are available for channels 1, 3, 4, 6 to 8, 12 are available for channel 2, and 10 are available for channel 5. • Input capture function • 39 output compare/input capture registers • Counter clear operation (synchronous clearing by compare match/input capture) • Simultaneous writing to multiple timer counters (TCNT) • Simultaneous register input/output by synchronous counter operation • Buffered operation • Support for cascade-connected operation • 43 interrupt sources • Automatic transfer of register data • Pulse output mode Toggle/PWM/complementary PWM/reset-synchronized PWM • Complementary PWM output mode Outputs non-overlapping waveforms for controlling 3-phase inverters Automatic specification of dead times PWM duty cycle: Selectable as any value from 0% to 100% Delay can be applied to requests for A/D conversion. Non-generation of interrupt requests at peak or trough values of counters can be selected. Double buffer configuration • Reset synchronous PWM mode Three phases of positive and negative PWM waveforms can be output with desired duty cycles. • Phase-counting mode: 16-bit mode (channels 1 and 2); 32-bit mode (channels 1 and 2) • Counter functionality for dead-time compensation • Generation of triggers for A/D converter conversion • A/D converter start triggers can be skipped • Digital filter function for signals on the input capture and external counter clock pins • PPG output trigger can be generated • Event linking by the ELC
	Port output enable 3 (POE3a)	• Control of the high-impedance state of the MTU3 waveform output pins • 5 pins for input from signal sources: POE0#, POE4#, POE8#, POE10#, POE11# • Initiation on detection of short-circuited outputs (detection of simultaneous PWM output to the active level) • Initiation by oscillation-stoppage detection or software • Additional programming of output control target pins is enabled
	Programmable pulse generator (PPG)	• (4 bits × 4 groups) × 2 units • Pulse output with the MTU or TPU output as a trigger • Maximum of 32 pulse-output possible

Table 1.4 Pin Functions (3/8)

Classifications	Pin Name	I/O	Description
16-bit timer pulse unit	TIOCA0, TIOCB0, TIOCC0, TIOCD0	I/O	The TGRA0 to TGRD0 input capture input/output compare output/PWM output pins
	TIOCA1, TIOCB1	I/O	The TGRA1 and TGRB1 input capture input/output compare output/PWM output pins
	TIOCA2, TIOCB2	I/O	The TGRA2 and TGRB2 input capture input/output compare output/PWM output pins
	TIOCA3, TIOCB3, TIOCC3, TIOCD3	I/O	The TGRA3 to TGRD3 input capture input/output compare output/PWM output pins
	TIOCA4, TIOCB4	I/O	The TGRA4 and TGRB4 input capture input/output compare output/PWM output pins
	TIOCA5, TIOCB5	I/O	The TGRA5 and TGRB5 input capture input/output compare output/PWM output pins
	TCLKA, TCLKB, TCLKC, TCLKD	Input	Input pins for external clock signals or for phase counting mode clock signals
Programmable pulse generator	PO0 to PO31	Output	Output pins for the pulse signals
8-bit timer	TMO0 to TMO3	Output	Compare match output pins
	TMCI0 to TMCI3	Input	Input pins for external clocks to be input to the counter
	TMRI0 to TMRI3	Input	Input pins for the counter reset
Compare match timer W	TIC0 to TIC3	Input	Input pins for CMTW
	TOC0 to TOC3	Output	Output pins for CMTW
Serial communications interface (SCIg)	• Asynchronous mode/clock synchronous mode		
	SCK0 to SCK9	I/O	Input/output pins for the clock
	RXD0 to RXD9	Input	Input pins for received data
	TXD0 to TXD9	Output	Output pins for transmitted data
	CTS0# to CTS9#	Input	Input pins for controlling the start of transmission and reception
	RTS0# to RTS9#	Output	Output pins for controlling the start of transmission and reception
	• Simple I^2C mode		
	SSCL0 to SSCL9	I/O	Input/output pins for the I^2C clock
	SSDA0 to SSDA9	I/O	Input/output pins for the I^2C data
	• Simple SPI mode		
	SCK0 to SCK9	I/O	Input/output pins for the clock
	SMISO0 to SMISO9	I/O	Input/output pins for slave transmission of data
	SMOSI0 to SMOSI9	I/O	Input/output pins for master transmission of data
	SS0# to SS9#	Input	Chip-select input pins



Note: This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.6, List of Pin and Pin Functions (176-Pin LFQFP).

Figure 1.5 Pin Assignment (176-Pin LFQFP)

Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA) (5/8)

Pin Number 177-Pin TFLGA 176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDSI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
L4		P25	CS5#/ EDACK1	MTIOC4C/ MTCLKB/ TIOCA4/PO5	RXD3/SMISO3/ SSCL3	SDHI_CD/HSYNC			ADTRG0 #
L12		PB6	A14	MTIOC3D/ TIOCA5/PO30	ET0_ETXD1/ RMII0_TXD1/ RXD9/SMISO9/ SSCL9/ SMISO11/ SSCL11/RXD11	SDSI_D0-B			
L13		PB3	A11	MTIOC0A/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE11#	ET0_RX_ER/ RMII0_RX_ER/ SCK4/SCK6	SDSI_D3-B	LCD_TC ON1-B		
L14		PB1	A9	MTIOC0C/ MTIOC4C/ TIOCB3/ TMCI0/PO25	ET0_ERXD0/ RMII0_RXD0/ TXD4/SMOSI4/ SSDA4/TXD6/ SMOSI6/SSDA6		LCD_TC ON3-B	IRQ4-DS	
L15		P72	A19/CS2#		ET0_MDC		LCD_DA TA23-A		
M1		P27	CS7#	MTIOC2B/ TMCI3/PO7	SCK1/RSPCKB-A				
M2		P26	CS6#	MTIOC2A/ TMO1/PO6	TXD1/SMOSI1/ SSDA1/CTS3#/ RTS3#/SS3#/ MOSIB-A				
M3		P24	CS4#/ EDREQ1	MTIOC4A/ MTCLKA/ TIOCB4/ TMRI1/PO4	SCK3/ USB0_VBUSEN	SDHI_WP/PIXCLK			
M4		P86		MTIOC4D/ TIOCA0	SMISO10/ SSCL10/RXD10	PIXD1			
M5		PJ2			TXD8/SMOSI8/ SSDA8/SSLC3-B		LCD_TC ON2-A		
M6		PJ1		MTIOC6A	RXD8/SMISO8/ SSCL8/SSLC2-B		LCD_TC ON3-A		
M7		P85		MTIOC6C/ TIOCC0			LCD_DA TA1-A		
M8		P55	D0[A0/D0]/ EDREQ0	MTIOC4D/ TMO3	ET0_EXOUT/ TXD7/SMOSI7/ SSDA7/MISOC-B/CRX1		LCD_DA TA5-A	IRQ10	
M9		P50	WR0#/WR#		TXD2/SMOSI2/ SSDA2/SSLB1-A				
M10		PC5	D3[A3/D3]/ A21/CS2#/ WAIT#	MTIOC3B/ MTCLKD/ TMRI2/PO29	ET0_ETXD2/ SCK8/SCK10/ RSPCKA-A	MMC_D5-A	LCD_DA TA11-A		
M11		P81	EDACK0	MTIOC3D/ PO27	ET0_ETXD0/ RMII0_TXD0/ SMISO10/ SSCL10/RXD10	QIO3-A/SDHI_CD/ MMC_D3-A	LCD_DA TA13-A		
M12		P77	CS7#	PO23	ET0_RX_ER/ RMII0_RX_ER/ SMOSI11/ SSDA11/TXD11	QSPCLK-A/ SDHI_CLK-A/ SDSI_CLK-A/ MMC_CLK-A	LCD_DA TA17-A		
M13		PB7	A15	MTIOC3B/ TIOCB5/PO31	ET0_CRS/ RMII0_CRS_DV/ TXD9/SMOSI9/ SSDA9/ SMOSI11/ SSDA11/TXD11	SDSI_D1-B			

Table 1.6 List of Pin and Pin Functions (176-Pin LFQFP) (5/8)

Pin Number 176-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDSI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
92	VSS								
93		P73	CS3#	PO16	ET0_WOL		LCD_EXTCLK-A		
94		PB7	A15	MTIOC3B/ TIOCB5/PO31	ET0_CRS/ RMII0_CRS_DV/ TXD9/SMOSI9/ SSDA9/ SMOSI11/ SSDA11/TXD11	SDSI_D1-B			
95		PB6	A14	MTIOC3D/ TIOCA5/PO30	ET0_ETXD1/ RMII0_TXD1/ RXD9/SMISO9/ SSCL9/ SMISO11/ SSCL11/RXD11	SDSI_D0-B			
96		PB5	A13	MTIOC2A/ MTIOC1B/ TIOCB4/ TMRI1/PO29/ POE4#	ET0_ETXD0/ RMII0_TXD0/ SCK9/SCK11	SDSI_CLK-B	LCD_CLK-B		
97		PB4	A12	TIOCA4/PO28	ET0_TX_EN/ RMII0_TXD_EN/ CTS9#/RTS9#/ SS9#/SS11#/ CTS11#/RTS11#	SDSI_CMD-B	LCD_TCON0-B		
98		PB3	A11	MTIOC0A/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE11#	ET0_RX_ER/ RMII0_RX_ER/ SCK4/SCK6	SDSI_D3-B	LCD_TCON1-B		
99		PB2	A10	TIOCC3/ TCLKC/PO26	ET0_RX_CLK/ REF50CK0/ CTS4#/RTS4#/ SS4#/CTS6#/ RTS6#/SS6#	SDSI_D2-B	LCD_TCON2-B		
100		PB1	A9	MTIOC0C/ MTIOC4C/ TIOCB3/ TMCI0/PO25	ET0_ERXD0/ RMII0_RXD0/ TXD4/SMOSI4/ SSDA4/TXD6/ SMOSI6/SSDA6		LCD_TCON3-B	IRQ4-DS	
101		P72	A19/CS2#		ET0_MDC		LCD_DATA23-A		
102		P71	A18/CS1#		ET0_MDIO				
103	VCC								
104		PB0	A8	MTIC5W/ TIOCA3/PO24	ET0_ERXD1/ RMII0_RXD1/ RXD4/SMISO4/ SSCL4/RXD6/ SMISO6/SSCL6		LCD_DATA0-B	IRQ12	
105	VSS								
106		PA7	A7	TIOCB2/PO23	ET0_WOL/ MISOA-B		LCD_DATA1-B		
107		PA6	A6	MTIC5V/ MTCLKB/ TIOCA2/ TMCI3/PO22/ POE10#	ET0_EXOUT/ CTS5#/RTS5#/ SS5#/MOSIA-B		LCD_DATA2-B		
108		PA5	A5	MTIOC6B/ TIOCB1/PO21	ET0_LINKSTA/ RSPCKA-B		LCD_DATA3-B		

Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA) (5/7)

Pin Number 145-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDSI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
K7		P51	WR1#/ BC1#/ WAIT#		SCK2/SSLB2-A				
K8	VCC								
K9	TRDATA0	P80	EDREQ0	MTIOC3B/ PO26	ET0_TX_EN/ RMII0_TXD_EN/ SCK10/RTS10#	QIO2-A/SDHI_WP/ MMC_D2-A			
K10	TRDATA6	P76	CS6#	PO22	ET0_RX_CLK/ REF50CK0/ SMISO11/ SSCL11/RXD11	QSSL-A/ SDHI_CMD-A/ SDSI_CMD-A/ MMC_CMD-A			
K11		PB7	A15	MTIOC3B/ TIOCB5/PO31	ET0_CRS/ RMII0_CRS_DV/ TXD9/SMOSI9/ SSDA9/ SMOSI11/ SSDA11/TXD11	SDSI_D1-B			
K12		PB6	A14	MTIOC3D/ TIOCA5/PO30	ET0_ETXD1/ RMII0_TXD1/ RXD9/SMISO9/ SSCL9/ SMISO11/ SSCL11/RXD11	SDSI_D0-B			
K13		PB5	A13	MTIOC2A/ MTIOC1B/ TIOCB4/ TMRI1/PO29/ POE4#	ET0_ETXD0/ RMII0_TXD0/ SCK9/SCK11	SDSI_CLK-B	LCD_CLK-B*1		
L1		P25	CS5#/ EDACK1	MTIOC4C/ MTCLKB/ TIOCA4/PO5	RXD3/SMISO3/ SSCL3	SDHI_CD/HSYNC			ADTRG0#
L2		P23	EDACK0	MTIOC3D/ MTCLKD/ TIOCD3/PO3	TXD3/SMOSI3/ SSDA3/CTS0#/ RTS0#/SS0#	SDHI_D1-C/PIXD7			
L3		P16		MTIOC3C/ MTIOC3D/ TIOCB1/ TCLKC/TMO2/ PO14/RTCOUT	TXD1/SMOSI1/ SSDA1/RXD3/ SMISO3/SSCL3/ SCL2-DS/ USB0_VBUSEN/ USB0_VBUS/ USB0_OVRCURB			IRQ6	ADTRG0#
L4		P24	CS4#/ EDREQ1	MTIOC4A/ MTCLKA/ TIOCB4/ TMRI1/PO4	SCK3/ USB0_VBUSEN	SDHI_WP/PIXCLK			
L5		P13		MTIOC0B/ TIOCA5/TMO3/ PO13	TXD2/SMOSI2/ SSDA2/ SDA0[FM+]			IRQ3	ADTRG1#
L6		P56	EDACK1	MTIOC3C/ TIOCA1	SCK7*1				
L7		P52	RD#		RXD2/SMISO2/ SSCL2/SSLB3-A				
L8	TRCLK	P83	EDACK1	MTIOC4C	ET0_CRS/ RMII0_CRS_DV/ SCK10/SS10#/ CTS10#				
L9		PC5	D3[A3/D3]*1/ A21/CS2#/ WAIT#	MTIOC3B/ MTCLKD/ TMRI2/PO29	ET0_ETXD2/ SCK8/SCK10/ RSPCKA-A	MMC_D5-A			
L10		PC4	A20/CS3#	MTIOC3D/ MTCLKC/ TMCI1/PO25/ POE0#	ET0_TX_CLK/ SCK5/CTS8#/ RTS8#/SS8#/ SS10#/CTS10#/ RTS10#/SSLA0-A	QMI-A/QIO1-A/ SDHI_D1-A/ SDSI_D1-A/ MMC_D1-A			

Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA) (6/7)

Pin Number 145-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCI, RSPI, RIIC, CAN, USB)	Memory Interface Camera Interface (QSPI, SDHI, SDSI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
L11		PC2	A18	MTIOC4B/ TCLKA/PO21	ET0_RX_DV/ RXD5/SMISO5/ SSCL5/SSLA3-A	SDHI_D3-A/ SDSI_D3-A/ MMC_CD-A			
L12	TRDATA4	P73	CS3#	PO16	ET0_WOL				
L13	VSS								
M1		P22	EDREQ0	MTIOC3B/ MTCLKC/ TIOCC3/ TMO0/PO2	SCK0/ USB0_OVRCURB	SDHI_D0-C*1/ PIXD6			
M2		P17		MTIOC3A/ MTIOC3B/ MTIOC4B/ TIOCB0/ TCLKD/TMO1/ PO15/POE8#	SCK1/TXD3/ SMOSI3/SSDA3/ SDA2-DS	SDHI_D3-C*1/ PIXD3		IRQ7	ADTRG1#
M3		P86		MTIOC4D/ TIOCA0	SMISO10/ SSCL10/RXD10	PIXD1			
M4		P12		TMCI1	RXD2/SMISO2/ SSCL2/ SCL0[FM+]			IRQ2	
M5	VCC_USB								
M6	VSS_USB								
M7		P50	WR0#/WR#		TXD2/SMOSI2/ SSDA2/SSLB1-A				
M8		PC6	D2[A2/D2]*1/ A22/CS1#	MTIOC3C/ MTCLKA/ TMCI2/PO30/ TIC0	ET0_ETXD3/ RXD8/SMISO8/ SSCL8/ SMISO10/ SSCL10/RXD10/ MOSIA-A	MMC_D6-A		IRQ13	
M9	TRDATA1	P81	EDACK0	MTIOC3D/ PO27	ET0_ETXD0/ RMII0_TXD0/ SMISO10/ SSCL10/RXD10	QIO3-A/SDHI_CD/ MMC_D3-A			
M10	TRDATA7	P77	CS7#	PO23	ET0_RX_ER/ RMII0_RX_ER/ SMOSI11/ SSDA11/TXD11	QSPCLK-A/ SDHI_CLK-A/ SDSI_CLK-A/ MMC_CLK-A			
M11		PC0	A16	MTIOC3C/ TCLKC/PO17	ET0_ERXD3/ CTS5#/RTS5#/ SS5#/SSLA1-A			IRQ14	
M12		PC1	A17	MTIOC3A/ TCLKD/PO18	ET0_ERXD2/ SCK5/SSLA2-A			IRQ12	
M13	VCC								
N1		P21		MTIOC1B/ MTIOC4A/ TIOCA3/ TMCI0/PO1	RXD0/SMISO0/ SSCL0/SCL1*1/ USB0_EXICEN	SDHI_CLK-C*1/ PIXD5		IRQ9	
N2		P20		MTIOC1A/ TIOCB3/ TMRI0/PO0	TXD0/SMOSI0/ SSDA0/SDA1*1/ USB0_ID	SDHI_CMD-C*1/ PIXD4		IRQ8	
N3		P87		MTIOC4C/ TIOCA2	SMOSI10/ SSDA10/TXD10	SDHI_D2-C*1/ PIXD2			
N4		P14		MTIOC3A/ MTCLKA/ TIOCB5/ TCLKA/TMRI2/ PO15	CTS1#/RTS1#/ SS1#/CTX1/ USB0_OVRCURA			IRQ4	
N5					USB0_DM				
N6					USB0_DP				

4. I/O Registers

This section gives information on the on-chip I/O register addresses. The information is given as shown below. Notes on writing to registers are also given at the end.

(1) I/O register addresses (address order)

- Registers are listed from the lower allocation addresses.
- Registers are classified according to module symbols.
- The number of access cycles indicates the number of cycles based on the specified reference clock.
- Among the internal I/O register area, addresses not listed in the list of registers are reserved. Reserved addresses must not be accessed. Do not access these addresses; otherwise, the operation when accessing these bits and subsequent operations cannot be guaranteed.

(2) Notes on writing to I/O registers

When writing to an I/O register, the CPU starts executing the subsequent instruction before completing I/O register write. This may cause the subsequent instruction to be executed before the post-update I/O register value is reflected on the operation.
As described in the following examples, special care is required for the cases in which the subsequent instruction must be executed after the post-update I/O register value is actually reflected.

[Examples of cases requiring special care]

- The subsequent instruction must be executed while an interrupt request is disabled with the IENj bit in IERn of the ICU (interrupt request enable bit) set to 0.
- A WAIT instruction is executed immediately after the preprocessing for causing a transition to the low power consumption state.

In the above cases, after writing to an I/O register, wait until the write operation is completed using the following procedure and then execute the subsequent instruction.

(a) Write to an I/O register.
(b) Read the value from the I/O register to a general register.
(c) Execute the operation using the value read.
(d) Execute the subsequent instruction.

[Instruction examples]

- Byte-size I/O registers

```
MOV.L  #SFR_ADDR, R1
MOV.B  #SFR_DATA, [R1]
CMP    [R1].UB, R1
;; Next process
```

- Word-size I/O registers

```
MOV.L  #SFR_ADDR, R1
MOV.W  #SFR_DATA, [R1]
CMP    [R1].W, R1
;; Next process
```

Table 4.1 List of I/O Registers (Address Order) (27 / 61)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 A08Ah	SCI4	I²C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A08Bh	SCI4	I²C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A08Ch	SCI4	I²C Status Register	SISR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A08Dh	SCI4	SPI Mode Register	SPMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A08Eh	SCI4	Transmit Data Register H	TDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A08Fh	SCI4	Transmit Data Register L	TDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A08Eh	SCI4	Transmit Data Register HL	TDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A090h	SCI4	Receive Data Register H	RDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A091h	SCI4	Receive Data Register L	RDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A090h	SCI4	Receive Data Register HL	RDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A092h	SCI4	Modulation Duty Register	MDDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A0h	SCI5	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A1h	SCI5	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A2h	SCI5	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A3h	SCI5	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A4h	SCI5	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A5h	SCI5	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A6h	SMCI5	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A7h	SCI5	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A8h	SCI5	Noise Filter Setting Register	SNFR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0A9h	SCI5	I²C Mode Register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0AAh	SCI5	I²C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi
0008 A0ABh	SCI5	I²C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh, SCIi

Table 4.1 List of I/O Registers (Address Order) (36 / 61)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 C04Bh	PORTB	Port Input Register	PIDR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C04Ch	PORTC	Port Input Register	PIDR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C04Dh	PORTD	Port Input Register	PIDR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C04Eh	PORTE	Port Input Register	PIDR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C04Fh	PORTF	Port Input Register	PIDR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C050h	PORTG	Port Input Register	PIDR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C052h	PORTJ	Port Input Register	PIDR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C060h	PORT0	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C061h	PORT1	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C062h	PORT2	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C063h	PORT3	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C064h	PORT4	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C065h	PORT5	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C066h	PORT6	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C067h	PORT7	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C068h	PORT8	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C069h	PORT9	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C06Ah	PORTA	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C06Bh	PORTB	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C06Ch	PORTC	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C06Dh	PORTD	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C06Eh	PORTE	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C06Fh	PORTF	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C070h	PORTG	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C072h	PORTJ	Port Mode Register	PMR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C080h	PORT0	Open-Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C081h	PORT0	Open-Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C082h	PORT1	Open-Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C083h	PORT1	Open-Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C084h	PORT2	Open-Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C085h	PORT2	Open-Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK	I/O Ports

Table 4.1 List of I/O Registers (Address Order) (43 / 61)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 C2A0h to 0008 C2BFh	SYSTEM	Deep Standby Backup Registers 0 to 31	DPSBKR0 to 31	8	8	4, 5 PCLKB	2, 3 ICLK	Low Power Consumption
0008 C400h	RTC	64-Hz Counter	R64CNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C402h	RTC	Second Counter	RSECCNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C402h	RTC	Binary Counter 0	BCNT0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C404h	RTC	Minute Counter	RMINCNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C404h	RTC	Binary Counter 1	BCNT1	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C406h	RTC	Hour Counter	RHRCNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C406h	RTC	Binary Counter 2	BCNT2	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C408h	RTC	Day-of-Week Counter	RWKCNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C408h	RTC	Binary Counter 3	BCNT3	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C40Ah	RTC	Date Counter	RDAYCNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C40Ch	RTC	Month Counter	RMONCNT	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C40Eh	RTC	Year Counter	RYRCNT	16	16	2, 3 PCLKB	2 ICLK	RTCd
0008 C410h	RTC	Second Alarm Register	RSECAR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C410h	RTC	Binary Counter 0 Alarm Register	BCNT0AR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C412h	RTC	Minute Alarm Register	RMINAR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C412h	RTC	Binary Counter 1 Alarm Register	BCNT1AR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C414h	RTC	Hour Alarm Register	RHRAR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C414h	RTC	Binary Counter 2 Alarm Register	BCNT2AR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C416h	RTC	Day-of-Week Alarm Register	RWKAR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C416h	RTC	Binary Counter 3 Alarm Register	BCNT3AR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C418h	RTC	Date Alarm Register	RDAYAR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C418h	RTC	Binary Counter 0 Alarm Enable Register	BCNT0AER	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C41Ah	RTC	Month Alarm Register	RMONAR	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C41Ah	RTC	Binary Counter 1 Alarm Enable Register	BCNT1AER	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C41Ch	RTC	Year Alarm Register	RYRAR	16	16	2, 3 PCLKB	2 ICLK	RTCd
0008 C41Ch	RTC	Binary Counter 2 Alarm Enable Register	BCNT2AER	16	16	2, 3 PCLKB	2 ICLK	RTCd
0008 C41Eh	RTC	Year Alarm Enable Register	RYRAREN	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C41Eh	RTC	Binary Counter 3 Alarm Enable Register	BCNT3AER	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C422h	RTC	RTC Control Register 1	RCR1	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C424h	RTC	RTC Control Register 2	RCR2	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C426h	RTC	RTC Control Register 3	RCR3	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C428h	RTC	RTC Control Register 4	RCR4	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C42Ah	RTC	Frequency Register H	RFRH	16	16	2, 3 PCLKB	2 ICLK	RTCd
0008 C42Ch	RTC	Frequency Register L	RFRL	16	16	2, 3 PCLKB	2 ICLK	RTCd
0008 C42Eh	RTC	Time Error Adjustment Register	RADJ	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C440h	RTC	Time Capture Control Register 0	RTCCR0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C442h	RTC	Time Capture Control Register 1	RTCCR1	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C444h	RTC	Time Capture Control Register 2	RTCCR2	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C452h	RTC	Second Capture Register 0	RSECCP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C452h	RTC	BCNT0 Capture Register 0	BCNT0CP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C454h	RTC	Minute Capture Register 0	RMINCP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C454h	RTC	BCNT1 Capture Register 0	BCNT1CP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C456h	RTC	Hour Capture Register 0	RHRCP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C456h	RTC	BCNT2 Capture Register 0	BCNT2CP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C45Ah	RTC	Date Capture Register 0	RDAYCP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C45Ah	RTC	BCNT3 Capture Register 0	BCNT3CP0	8	8	2, 3 PCLKB	2 ICLK	RTCd
0008 C45Ch	RTC	Month Capture Register 0	RMONCP0	8	8	2, 3 PCLKB	2 ICLK	RTCd

Table 5.15 EXTAL Clock Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
$T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
EXTAL external clock input cycle time	t_{EXcyc}	41.66	—	—	ns	Figure 5.4
EXTAL external clock input frequency	f_{EXMAIN}	—	—	24	MHz	
EXTAL external clock input high pulse width	t_{EXH}	15.83	—	—	ns	
EXTAL external clock input low pulse width	t_{EXL}	15.83	—	—	ns	
EXTAL external clock rising time	t_{EXr}	—	—	5	ns	
EXTAL external clock falling time	t_{EXf}	—	—	5	ns	

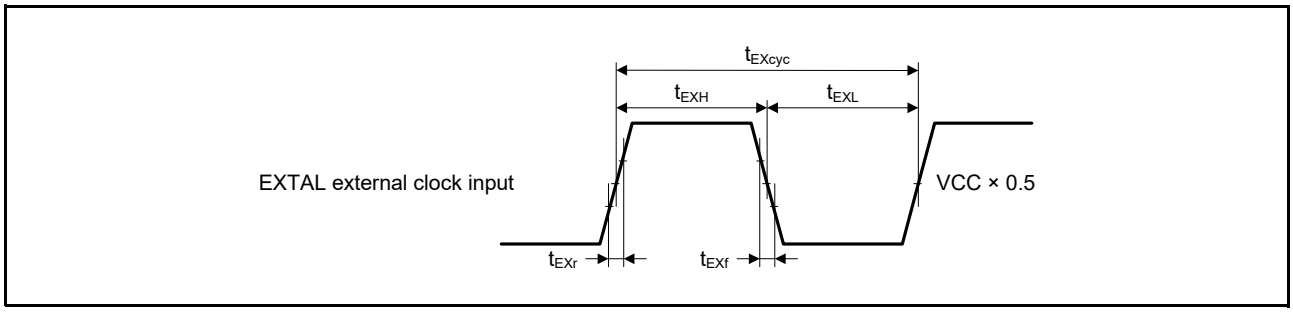


Figure 5.4 EXTAL External Clock Input Timing

Table 5.16 Main Clock Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
$T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Main clock oscillation frequency	f_{MAIN}	8	—	24	MHz	
Main clock oscillator stabilization time (crystal)	$t_{MAINOSC}$	—	—	—*1	ms	Figure 5.5
Main clock oscillation stabilization wait time (crystal)	$t_{MAINOSCWT}$	—	—	—*2	ms	

Note 1. When using a main clock, ask the manufacturer of the oscillator to evaluate its oscillation. Refer to the results of evaluation provided by the manufacturer for the oscillation stabilization time.

Note 2. The number of cycles selected by the value of the MOSCWTCR.MSTS[7:0] bits determines the main clock oscillation stabilization wait time in accord with the formula below.
$t_{MAINOSCWT}$ = [(MSTS[7:0] bits × 32) + 10] / f_{LOCO}

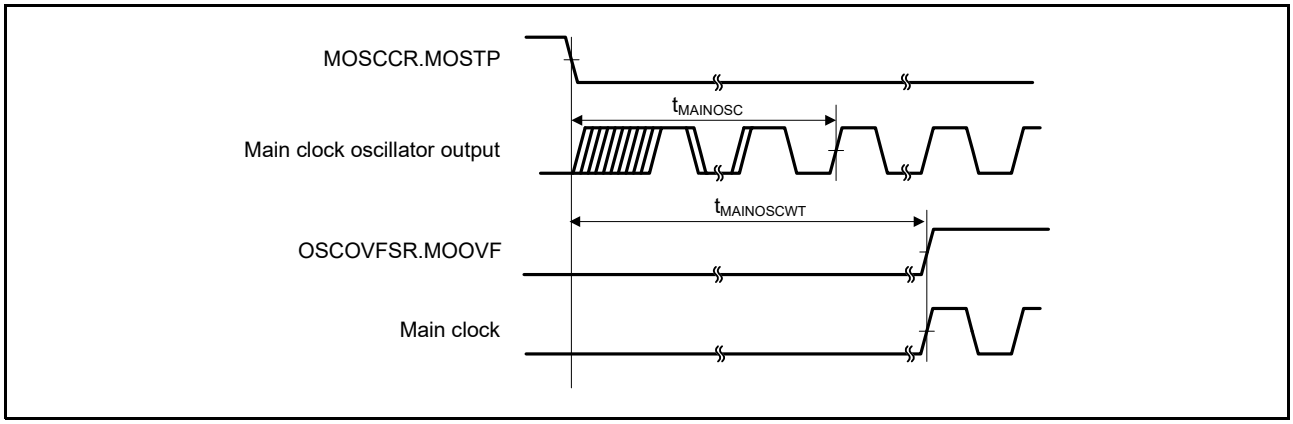


Figure 5.5 Main Clock Oscillation Start Timing

Table 5.19 PLL Clock Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
$T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
PLL clock oscillation frequency	f_{PLL}	120	—	240	MHz	
PLL clock oscillation stabilization wait time	t_{PLLWT}	—	259	320	µs	Figure 5.10

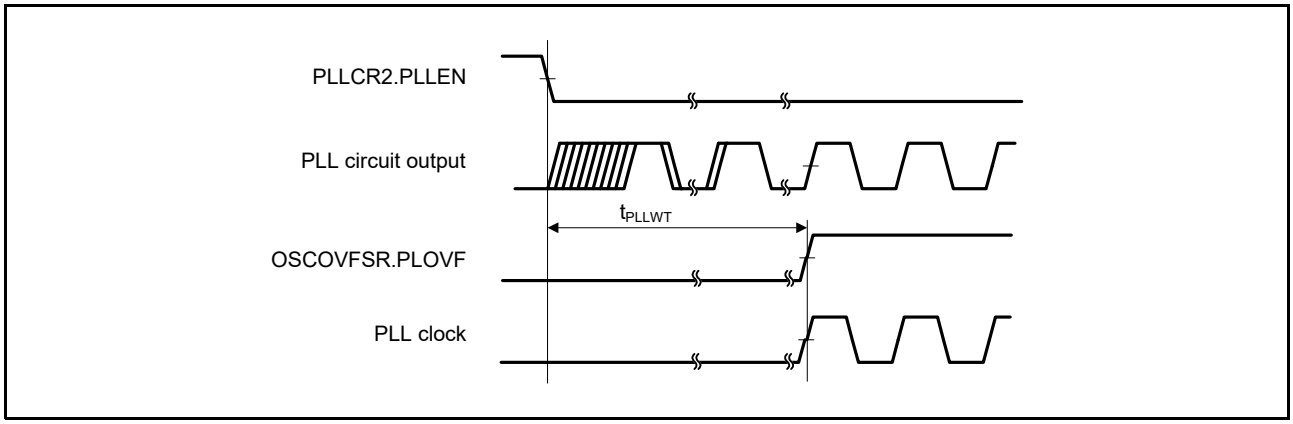


Figure 5.10 PLL Clock Oscillation Start Timing

Table 5.20 Sub-Clock Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
V_{BATT} = 2.0 to 3.6 V, $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Sub-clock oscillation frequency	f_{SUB}	—	32.768	—	kHz	
Sub-clock oscillation stabilization time	t_{SUBOSC}	—	—	*1	s	Figure 5.11
Sub-clock oscillation stabilization wait time	$t_{SUBOSCWT}$	—	—	*2	s	

Note 1. When using a sub-clock, ask the manufacturer of the oscillator to evaluate its oscillation. Refer to the results of evaluation provided by the manufacturer for the oscillation stabilization time.

Note 2. The number of cycles selected by the value of the SOSCWTCR.SSTS[7:0] bits determines the sub-clock oscillation stabilization wait time in accord with the formula below.
$t_{SUBOSCWT}$ = [(SSTS[7:0] bits × 16384) + 10] / f_{LOCO}

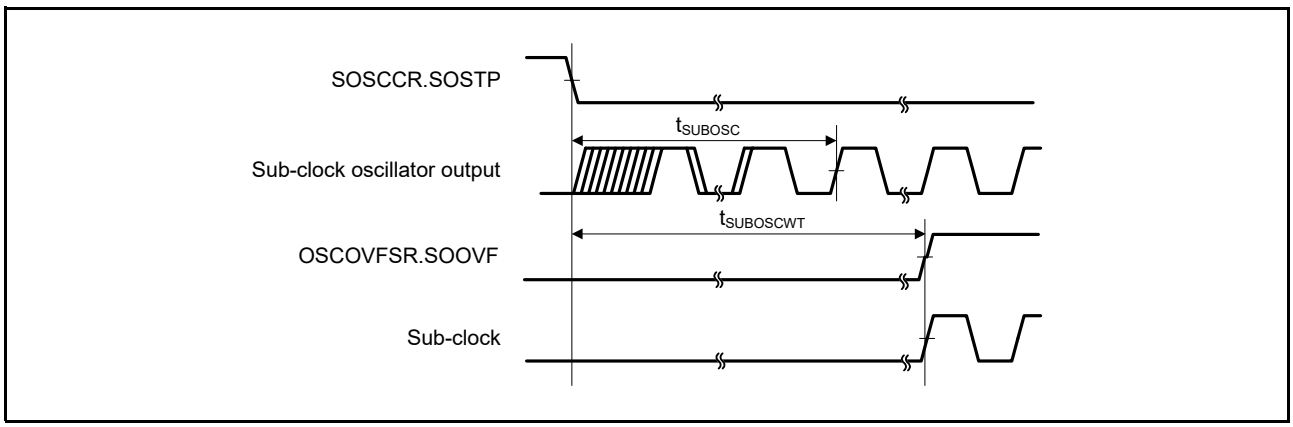


Figure 5.11 Sub-Clock Oscillation Start Timing

Table 5.41 ETHERC Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$,
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF,
High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit	Test Conditions
ETHERC (RMII)	REF50CK cycle time	T_{ck}	20	—	ns	Figure 5.56 to Figure 5.58
	REF50CK frequency Typ. 50 MHz	—	—	50 + 100 ppm	MHz	
	REF50CK duty	—	35	65	%	
	REF50CK rise/fall time	$T_{ckr/ckf}$	0.5	3.5	ns	
	RMII0_xxxx*1 output delay time	T_{co}	2.5	15.0	ns	
	RMII0_xxxx*2 setup time	T_{su}	3	—	ns	
	RMII0_xxxx*2 hold time	T_{hd}	1	—	ns	
	RMII0_xxxx*1, *2 rise/fall time	T_r/T_f	0.5	5	ns	
	ET0_WOL output delay time	t_{WOLd}	1	23.5	ns	Figure 5.60
ETHERC (MII)	ET0_TX_CLK cycle time	t_{Tcyc}	40	—	ns	—
	ET0_TX_EN output delay time	t_{TENd}	1	20	ns	Figure 5.61
	ET0_ETXD0 to ET0_ETXD3 output delay time	t_{MTDd}	1	20	ns	
	ET0_CRS setup time	t_{CRSs}	10	—	ns	
	ET0_CRS hold time	t_{CRSh}	10	—	ns	
	ET0_COL setup time	t_{COLs}	10	—	ns	Figure 5.62
	ET0_COL hold time	t_{COLh}	10	—	ns	
	ET0_RX_CLK cycle time	t_{TRcyc}	40	—	ns	—
	ET0_RX_DV setup time	t_{RDVs}	10	—	ns	Figure 5.63
	ET0_RX_DV hold time	t_{RDVh}	10	—	ns	
	ET0_ERXD0 to ET0_ERXD3 setup time	t_{MRDs}	10	—	ns	
	ET0_ERXD0 to ET0_ERXD3 hold time	t_{MRDh}	10	—	ns	
	ET0_RX_ER setup time	t_{RERs}	10	—	ns	Figure 5.64
	ET0_RX_ER hold time	t_{RERh}	10	—	ns	
	ET0_WOL output delay time	t_{WOLd}	1	23.5	ns	Figure 5.65

Note 1. RMII0_TXD_EN, RMII0_TXD1, RMII0_TXD0
Note 2. RMII0_CRS_DV, RMII0_RXD1, RMII0_RXD0, RMII0_RX_ER

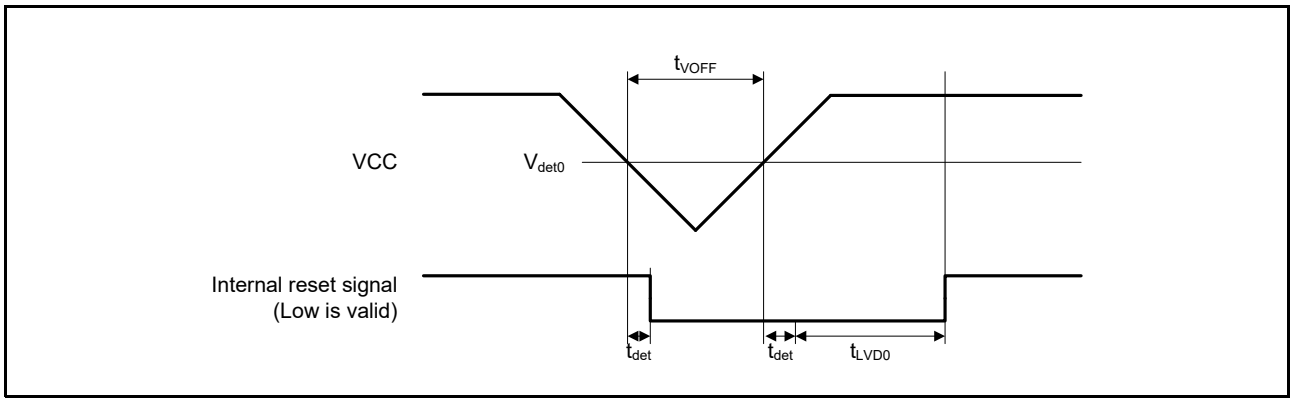


Figure 5.77 Voltage Detection Circuit Timing (V_{det0})

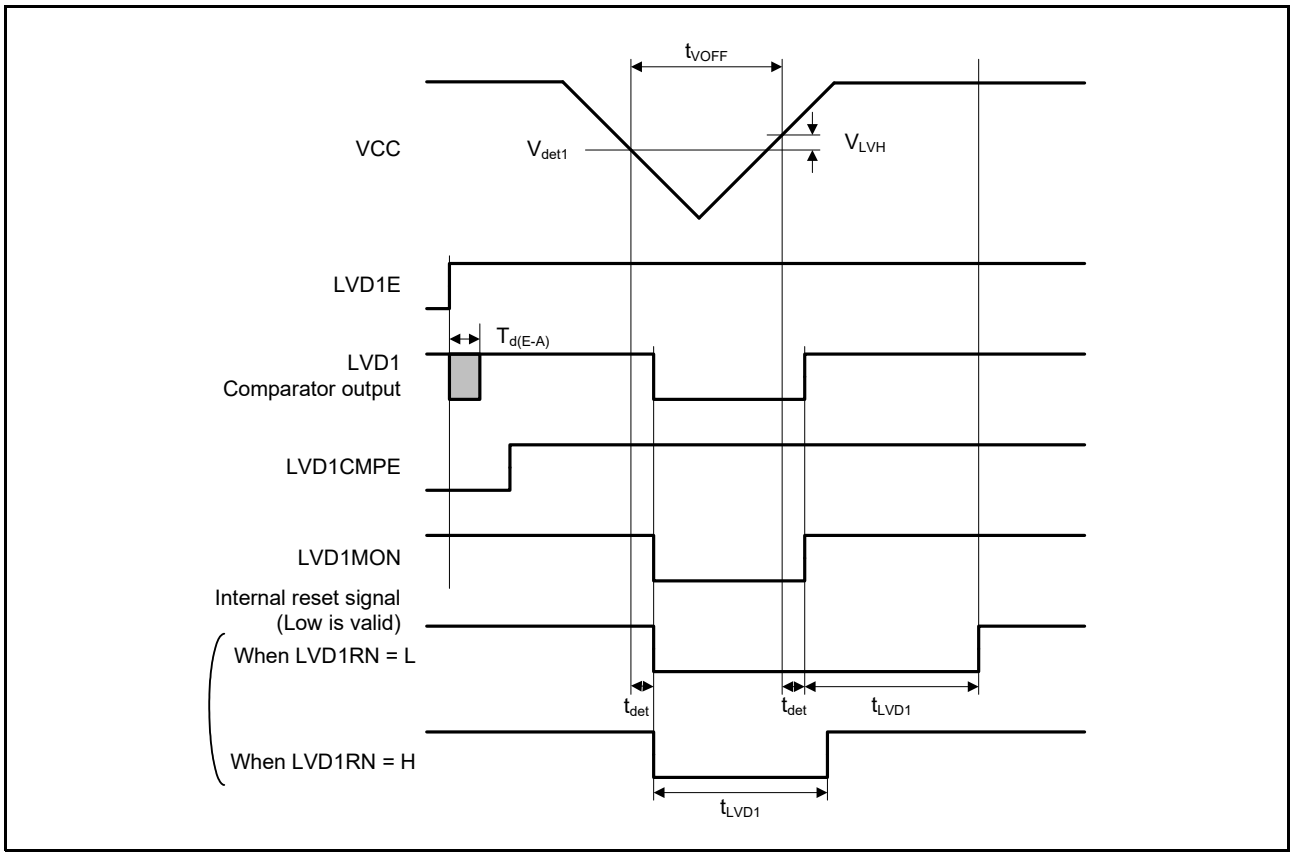


Figure 5.78 Voltage Detection Circuit Timing (V_{det1})

Table 5.55 Data Flash Memory Characteristics

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
Temperature range for programming/erasure: $T_a = T_{opr}$

Item		Symbol	FCLK = 4 MHz			FCLK = 15 MHz			20 MHz ≤ FCLK ≤ 60 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time	4 bytes	t_{DP4}	—	0.36	3.8	—	0.18	1.9	—	0.16	1.7	ms
Erasure time	64 bytes	t_{DP64}	—	3.1	18	—	1.9	11	—	1.7	10	ms
	128 bytes	t_{DP128}	—	4.7	27	—	2.9	16	—	2.6	15	ms
	256 bytes	t_{DP256}	—	8.9	50	—	5.4	31	—	4.9	28	ms
Blank check time	4 bytes	t_{DBC4}	—	—	84	—	—	33	—	—	30	µs
Reprogramming/erasure cycle*1		N_{DPEC}	100000 *2	—	—	100000 *2	—	—	100000 *2	—	—	Times
Suspend delay time during programming		t_{DSPD}	—	—	264	—	—	132	—	—	120	µs
First suspend delay time during erasure (in suspend priority mode)	64 bytes	—	—	—	216	—	—	132	—	—	120	µs
	128 bytes	—	—	—	216	—	—	132	—	—	120	µs
	256 bytes	—	—	—	216	—	—	132	—	—	120	µs
Second suspend delay time during erasure (in suspend priority mode)	64 bytes	—	—	—	300	—	—	300	—	—	300	µs
	128 bytes	—	—	—	390	—	—	390	—	—	390	µs
	256 bytes	—	—	—	570	—	—	570	—	—	570	µs
Suspend delay time during erasing (in suspend priority mode)	64 bytes	—	—	—	300	—	—	300	—	—	300	µs
	128 bytes	—	—	—	390	—	—	390	—	—	390	µs
	256 bytes	—	—	—	570	—	—	570	—	—	570	µs
Forced stop command		t_{FD}	—	—	32	—	—	22	—	—	20	µs
Data hold time*3		t_{DDRP}	10	—	—	10	—	—	10	—	—	Year

Note 1. Definition of reprogram/erase cycle:
The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 100000), erasing can be performed n times for each block. For instance, when 4-byte programming is performed 512 times for different addresses in 2-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).

Note 2. This is the minimum number of times to guarantee all the characteristics after reprogramming (guaranteed range is from 1 to the value of the minimum value).

Note 3. This shows the characteristics when reprogramming is performed within the specified range, including the minimum value.

5.12 Boundary Scan

Table 5.56 Boundary Scan Characteristics

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,
$T_a = T_{opr}$,
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF,
High-drive output is selected by the driving ability control register.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
TCK clock cycle time	t_{TCKcyc}	100	—	—	ns	Figure 5.83
TCK clock high pulse width	t_{TCKH}	45	—	—	ns	
TCK clock low pulse width	t_{TCKL}	45	—	—	ns	
TCK clock rise time	t_{TCKr}	—	—	5	ns	
TCK clock fall time	t_{TCKf}	—	—	5	ns	
TRST# pulse width	t_{TRSTW}	20	—	—	t_{TCKcyc}	Figure 5.84
TMS setup time	t_{TMSS}	20	—	—	ns	Figure 5.85
TMS hold time	t_{TMSH}	20	—	—	ns	
TDI setup time	t_{TDIS}	20	—	—	ns	
TDI hold time	t_{TDIH}	20	—	—	ns	
TDO data delay time	t_{TDOD}	—	—	40	ns	

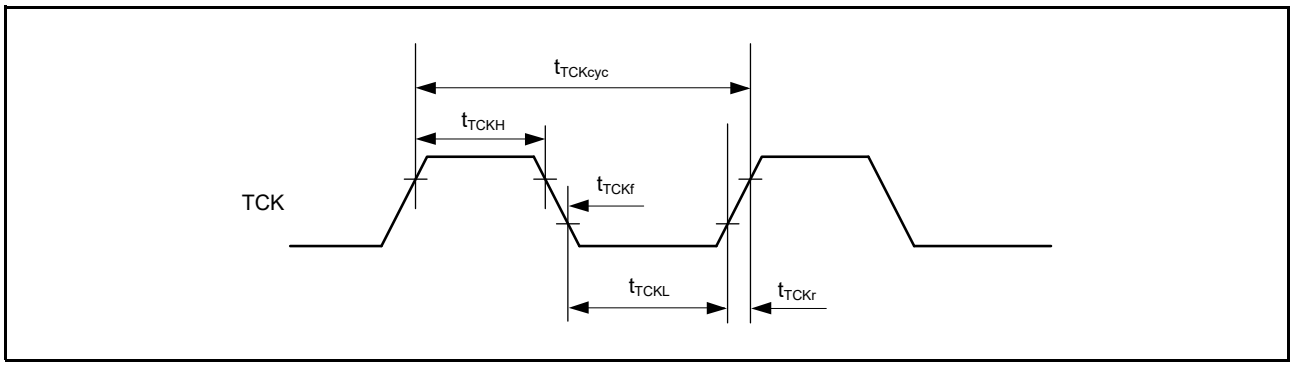


Figure 5.83 Boundary Scan TCK Timing

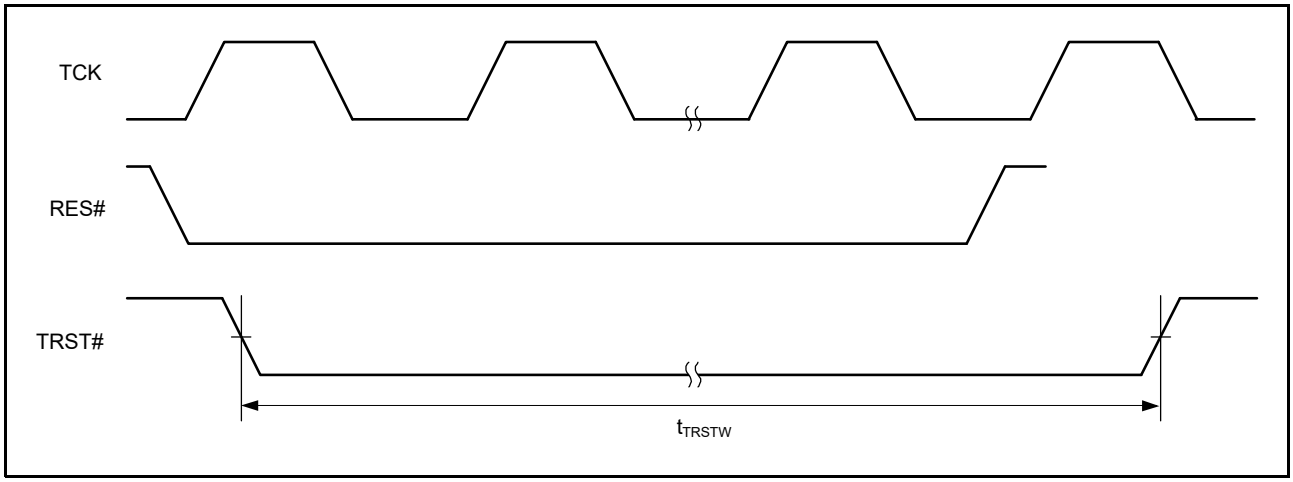


Figure 5.84 Boundary Scan TRST# Timing

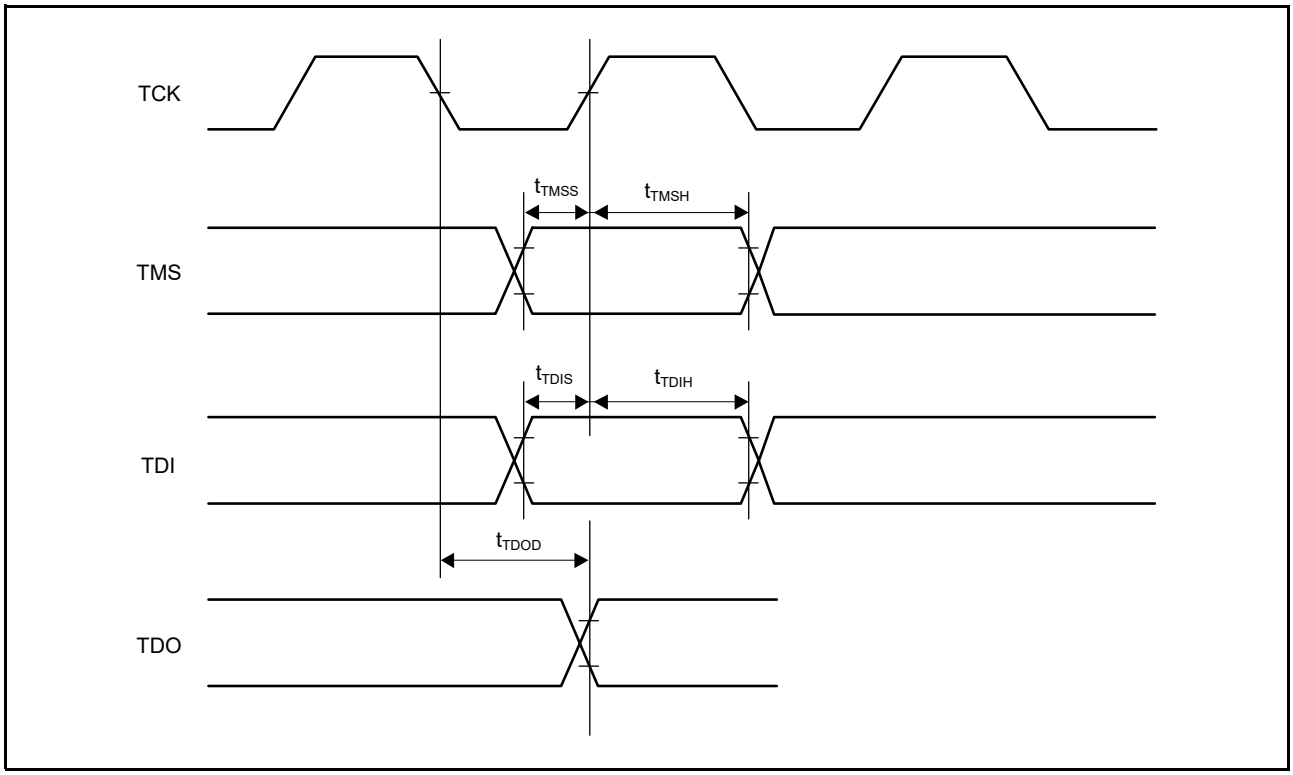
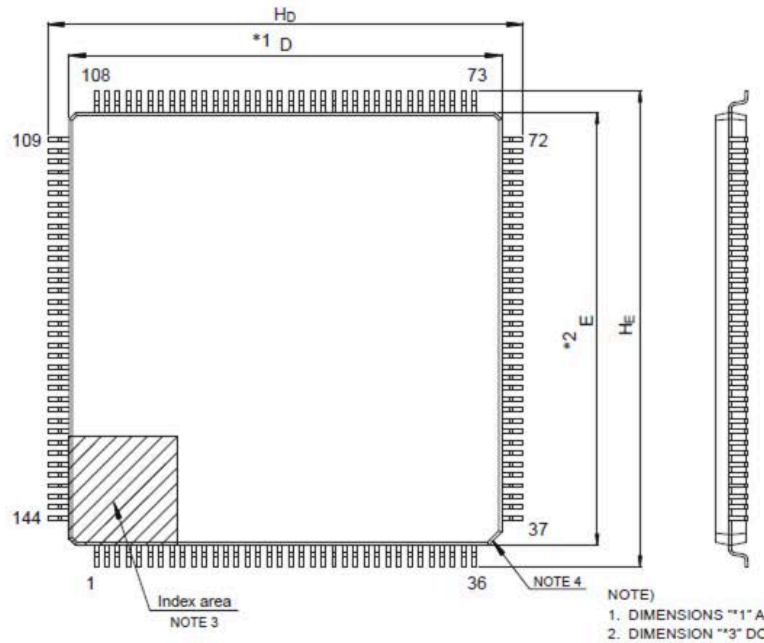


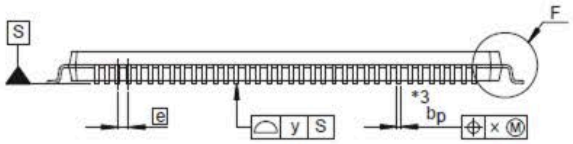
Figure 5.85 Boundary Scan Input/Output Timing

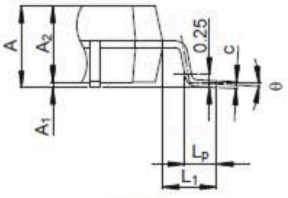
JEITA Package Code	RENESAS Code	Previous Code	MASS (Typ) [g]
P-LFQFP144-20x20-0.50	PLQP0144KA-B	—	1.2

Unit: mm



NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.
3. PIN 1 VISUAL INDEX FEATURE MAY VARY, BUT MUST BE LOCATED WITHIN THE HATCHED AREA.
4. CHAMFERS AT CORNERS ARE OPTIONAL, SIZE MAY VARY.



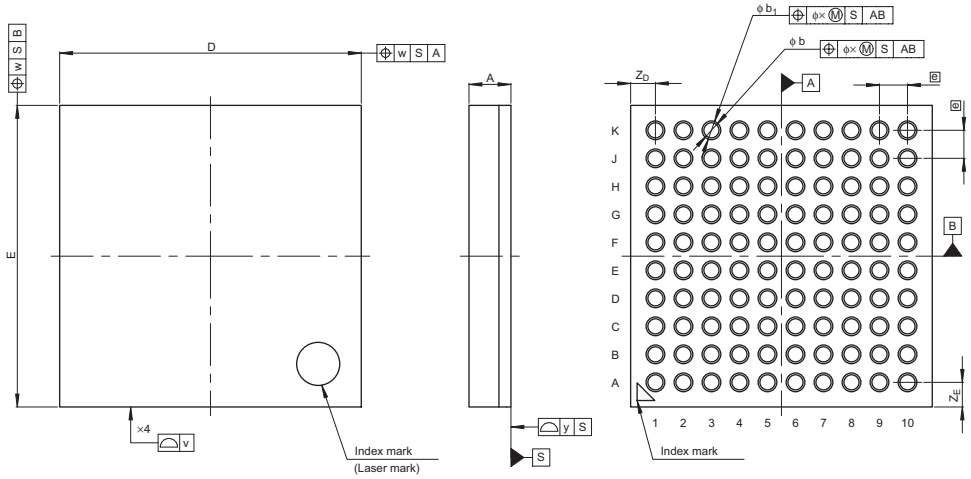


Detail F

Reference Symbol	Dimensions in millimeters		
	Min	Nom	Max
D	19.9	20.0	20.1
E	19.9	20.0	20.1
A_2	—	1.4	—
H_D	21.8	22.0	22.2
H_E	21.8	22.0	22.2
A	—	—	1.7
A_1	0.05	—	0.15
b_p	0.17	0.20	0.27
c	0.09	—	0.20
θ	0°	3.5°	8°
e	—	0.5	—
x	—	—	0.08
y	—	—	0.08
L_p	0.45	0.6	0.75
L_1	—	1.0	—

Figure E 144-Pin LFQFP (PLQP0144KA-B)

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-TFLGA100-7x7-0.65	PTLG0100JA-A	100F0G	0.1g



Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	7.0	—
E	—	7.0	—
v	—	—	0.15
w	—	—	0.20
A	—	—	1.05
e	—	0.65	—
b	0.31	0.35	0.39
b_1	0.385	0.435	0.485
x	—	—	0.08
y	—	—	0.10
Z_D	—	0.575	—
Z_E	—	0.575	—

Figure F 100-Pin TFLGA (PTLG0100JA-A)